



DOCUMENT CHANGE REQUEST

DCR number 1223 Changes required for: General

Date: 2019/06/06

Date sent: 2018/12/07

Originator: Steve Thacker

Organisation: ESCC Executive
Secretariat

Status: IMPLEMENTED

Title: DESTRUCTIVE PHYSICAL ANALYSIS OF EEE COMPONENTS

Number: 21001 Issue: 2

Other documents affected:

Page:

98

Paragraph:

Appendix A16.1

Original wording:

15: Wire Bond Strength Test: MIL-STD-750 Method 2036

Proposed wording:

In Appendix A16.1, correct the Wire Bond Strength Test Method to be 2037 (was 2036)

i.e.

15: Wire Bond Strength Test: MIL-STD-750 Method 2037

Justification:

typographic error

Attachments:

N/A

Modifications:

N/A

Approval signature:

Date signed:

2019-06-06